

Amendments to the Specification

Please insert the following paragraph before the paragraph beginning on line 7 of page 6:

In addition, the bridging chip 100 includes an input/output interface (IO_INT) 140 coupled to the SIE 125. The input/output interface 140 is coupled to a memory 142, a RAM control circuit (RAMCTL) 144 and a global control circuit 146. The global control circuit 146 is coupled to a translate circuit (XLATE) 148. The disk interface 115 is coupled to the RAM control circuit 144, the global control circuit 146, and the translate circuit 148.

Please replace the paragraph beginning on line 7 of page 6 with the following paragraph:

More specifically, an ATA/ATAPI Interface serves as an input 110 to receive ATA/ATAPI signals from a read unit of the mass storage device (not shown). The Disk Interface (DISK_INT) 115 receives the ATA/ATAPI signals from the ATA/ATAPI Interface 110 and transmits them to the other components. The remaining chip components, such as the input/output interface 140, the RAM control circuit 144, the global control circuit 146, and the translate circuit (XLATE) 148 provide conversion logic and are used to buffer and convert the ATA/ATAPI signals into USB 2.0 signals. The resulting USB signals are output to a USB Interface 135 through the USB 2.0 physical interface transceiver (PHY) 130.